

PATENT APPLICATION

Express Mail Label No.: EL 640 011 325 US

IN THE U.S. PATENT AND TRADEMARK OFFICE

May 7, 2001

Applicant(s) : Chikao IKENAGA et al.

For : FRAME FOR SEMICONDUCTOR PACKAGE

Atty. Docket No.: OPS Case 533

Assistant Commissioner for Patents
Washington, DC 20231

AMENDMENT BEFORE FIRST OFFICE ACTION

Sir:

Prior to issuance of the first Office Action in the
above-identified application, kindly enter the following:

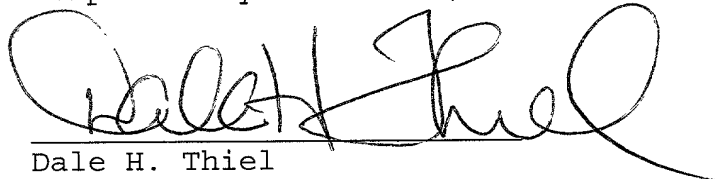
IN THE SPECIFICATION

Kindly amend Paragraphs 0014 and 0015, as indicated on
the attached marked-up page. A replacement page, showing
Paragraphs 0014 and 0015 in clean form, is also attached.

REMARKS

The above Amendment is being submitted to conform the
brief descriptions of Figures 3 and 4 with the drawing sheets.

Respectfully submitted,



Dale H. Thiel

DHT/jp

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Encl: Marked-up Paragraphs 0014 and 0015 (1 page)
Replacement Paragraphs 0014 and 0015 (1 page)

112.9803

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Marked-up Amended Paragraphs 0014 and 0015

[0014] ~~Fig. 3 is an explanatory view~~Figs. 3(A) and 3(B) are
explanatory views of a frame of individually molding type.

[0015] ~~Fig. 4 is an explanatory view~~Figs. 4(A) and 4(B) are
explanatory views of a frame of collectively molding type.

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Replacement Paragraphs 0014 and 0015

[0014] Figs. 3(A) and 3(B) are explanatory views of a frame of individually molding type.

[0015] Figs. 4(A) and 4(B) are explanatory views of a frame of collectively molding type.